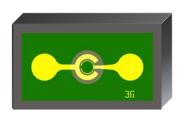
Introduction



# DATASHEET



This high performance product is a front side illuminated InGaAs PIN photodiode chip that features dumbbell contact pads for versatile wirebonding. It has very low capacitance, high responsivity, extremely low dark current and excellent reliability. This product has a  $36\mu m$  detection window, and is intended primary to be integrated with a pre-amplifier in a hermetic TO package, for 10Gbps optical receivers operating at 1310nm or 1550nm with 9/125 $\mu m$  single mode fiber.

## **Key Features**

- Mesa structure with GCS proprietary epi design and process technologies
- 36µm optical detection window
- High bandwidth up to 12GHz
- Front-sided dumbbell contact pads for versatile wire bonding
- Excellent low dark current and capacitance
- -40C to 85C operation range
- Highly robust 4" IC wafer fab with fast cycle-time
- Deliverable in GCS Known Good Die<sup>™</sup> with 100% testing and inspection
- RoHS compliant

	Conditions	Min.	Typical	Max.	Unit	Notes			
Bandwidth	-5V		12	-	GHz				
Wavelength range		910	1310/1550	1650	nm				
Capacitance	-5 V, 1 MHz		0.12	0.17	pF				
Responsivity	@1310 nm	0.8	0.9	-	A/W				
Dark current	-5V	-	0.3	3	nA				
Reverse Breakdown	-20V	-	-	1	μA				

## SPECIFICATIONS (T=25C°)

## Absolute Maximum Rating

Parameter	Rating		
Operating Temperature	-40C to 85C		
Storage Temperature	-40C to 125C		
Soldering Temperature	320C / 5 sec		

# Applications

- IEEE 10GBASE-LR/ER
- 10G Ethernet
- 8G Fiber Channel
- SONET OC-192 SR1/IR2
- WDM, ATM

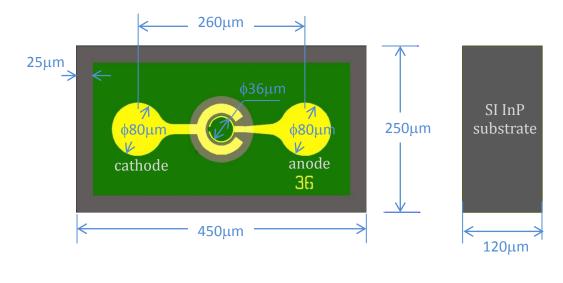
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Made in USA

#### **Dimensions**

	Conditions	Min.	Typical	Max.	Unit	Notes
Detection window			36		μm	
Bonding pad size			80		μm	for both p- and n- pads
Metal height of bond pad		1.4	1.6	-	μm	Au metal
Die height		110	120	130	μm	
Die width		240	250	260	μm	
Die length		440	450	460	μm	



P/N: DO048\_36um\_B1

Attention: InP brittle material and electrostatic sensitive device, observe precaution for handling.

#### **Contact Information**

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About GCS: GCS has a long history manufacturing and shipping both GaAs and InGaAs based photo diodes since 2000. Our state of art manufacturing facility is located in Torrance, California, and has about 10,000 square feet of fab space with a capability of about 1200 4-inch wafers per month and expandable to 2000 wafers per month. GCS as a world-class semiconductor device manufacturer has been delivering a total of over 30 million photo diodes with various date rates and applications used for optical communications, which have been deployed in field by top tier optical transceiver companies worldwide.

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